

# N-Channel Logic Level Enhancement Mode Field Effect Transistor

# **BSS138K**

#### **Features**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Green Compound
- ESD HBM = 2000 V as per JEDEC A114A;
   ESD CDM = 2000 V as per JEDEC C101C
- This Device is Pb-Free and is RoHS Compliant

#### **ABSOLUTE MAXIMUM RATINGS**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$  (Note 1)

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	50	V
V <sub>GSS</sub>	Gate-Source Voltage	±12	V
I <sub>D</sub>	Drain Current – Continuous	0.22	Α
	Drain Current – Pulsed	0.88	
$P_{D}$	Total Device Dissipation	350	mV
	Derating above T <sub>A</sub> = 25°C	2.8	mW/°C
$T_J$	Operating Junction Temperature Range	-55 to +150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C

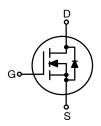
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 These ratings are limiting values above which the serviceability of any semiconductor device maybe impaired.

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	350	٧

2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size.





SOT-23-3 CASE 318-08

#### **MARKING DIAGRAM**



SK = Specific Device Code

M = Assembly Operation Month

= Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BSS138K	SOT-23-3 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# **BSS138K**

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Drain—Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate—Body Leakage	$V_{GS} = 0 \text{ V, } I_D = 10 \mu\text{A}$ $I_D = 250 \mu\text{A, Referenced to } 25^{\circ}\text{C}$ $V_{DS} = 50 \text{ V, } V_{GS} = 0 \text{ V}$	50	0.11	-	V
Breakdown Voltage Temperature Coefficient  Zero Gate Voltage Drain Current	$I_D$ = 250 $\mu$ A, Referenced to 25°C $V_{DS}$ = 50 V, $V_{GS}$ = 0 V		0.11	-	·
Coefficient  Zero Gate Voltage Drain Current	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V	-	0.11	_	1
					V/°C
Gate–Body Leakage		-	_	0.1	μΑ
	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±1	μΑ
	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	_	-	±0.5	
	$V_{GS} = \pm 5 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±0.05	
TERISTICS	•				
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6	-	1.2	V
Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 1 mA, Referenced to 25°C	-	-1.4	_	mV/°C
Static Drain-Source On-Resistance	$V_{GS} = 1.8 \text{ V}, I_D = 50 \text{ mA}$	-	-	2.5	Ω
	$V_{GS} = 2.5 \text{ V}, I_D = 50 \text{ mA}$	-	-	2.0	
	$V_{GS} = 5 \text{ V}, I_D = 50 \text{ mA},$	-	-	1.6	1
On-State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 5 V	0.2	-	-	Α
Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 200 mA	200	_	-	mS
ARACTERISTICS	•				
Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,	-	58	-	pF
Output Capacitance	f = 1.0 MHz	-	9.75	-	1
Reverse Transfer Capacitance	1	-	5.2	-	1
Gate Resistance	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 mV	_	281	-	Ω
CHARACTERISTICS	•				
Turn-On Delay Time	$V_{DD} = 30 \text{ V}, I_D = 0.29 \text{ A},$	-	_	5	ns
Turn-On Rise Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$	-	-	5	1
Turn-Off Delay Time		-	-	60	1
Turn-Off Fall Time		-	-	35	
Total Gate Charge	V <sub>DS</sub> = 25 V, I <sub>D</sub> = 0.2 A, V <sub>GS</sub> = 10 V, I <sub>G</sub> = 0.1 mA	-	-	2.4	nC
Gate-Source Charge		_	-	0.5	1
Gate-Drain Charge		_	-	0.5	1
RCE DIODE CHARACTERISTICS AND MA	AXIMUM RATINGS				
Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V, } I_{S} = 115 \text{ mA}$	_	_	1.2	V
	Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient  Static Drain—Source On—Resistance  On—State Drain Current Forward Transconductance  ARACTERISTICS Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance CHARACTERISTICS Turn—On Delay Time Turn—On Rise Time Turn—Off Delay Time Turn—Off Fall Time Total Gate Charge Gate—Source Charge Gate—Drain Charge  GCE DIODE CHARACTERISTICS AND MARKET	TERISTICS         Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ Gate Threshold Voltage Temperature Coefficient $I_D = 1 \text{ mA}$ , Referenced to $25^{\circ}$ C         Static Drain—Source On—Resistance         V <sub>GS</sub> = 1.8 V, $I_D = 50 \text{ mA}$ V <sub>GS</sub> = 2.5 V, $I_D = 50 \text{ mA}$ V <sub>GS</sub> = 5 V, $I_D = 50 \text{ mA}$ V <sub>GS</sub> = 10 V, $V_{DS} = 5 \text{ V}$ Forward Transconductance         V <sub>DS</sub> = 10 V, $I_D = 200 \text{ mA}$ ARACTERISTICS         Input Capacitance         V <sub>DS</sub> = 25 V, $V_{GS} = 0 \text{ V}$ , $I_D = 1.0 \text{ MHz}$ CHARACTERISTICS         Turn—On Delay Time       V <sub>DD</sub> = 30 V, $I_D = 0.29 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $I_{GEN} = 6 \Omega$ Turn—Off Delay Time       V <sub>DS</sub> = 25 V, $I_D = 0.29 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $I_{GEN} = 6 \Omega$ Turn—Off Fall Time         Total Gate Charge       V <sub>DS</sub> = 25 V, $I_D = 0.2 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $I_G = 0.1 \text{ mA}$ Gate—Drain Charge         Gate—Drain Charge         Gate—Drain Charge         CE DIODE CHARACTERISTICS AND MAXIMUM RATINGS	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250  \mu A$ 0.6         Gate Threshold Voltage Temperature Coefficient $I_D = 1  \text{mA}$ , Referenced to 25°C       —         Static Drain—Source On—Resistance $V_{GS} = 1.8  \text{V}$ , $I_D = 50  \text{mA}$ — $V_{GS} = 2.5  \text{V}$ , $I_D = 50  \text{mA}$ —         V <sub>GS</sub> = 5 V, $I_D = 50  \text{mA}$ —         V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 5 V       0.2         Forward Transconductance $V_{DS} = 10  \text{V}$ , $I_D = 200  \text{mA}$ 200         ARACTERISTICS         Input Capacitance $V_{DS} = 25  \text{V}$ , $V_{GS} = 0  \text{V}$ , $I_D = 200  \text{mA}$ —         Output Capacitance $V_{DS} = 25  \text{V}$ , $V_{GS} = 10  \text{mV}$ —         CHARACTERISTICS         Turn—On Delay Time $V_{DS} = 5  \text{V}$ , $V_{GS} = 10  \text{mV}$ —         CHARACTERISTICS         Turn—On Rise Time $V_{CS} = 10  \text{V}$ , $V_{CS} = 10  \text{mV}$ —         Turn—Off Delay Time $V_{CS} = 10  \text{V}$ , $V_{CS} = 10  \text{V}$ —         Turn—Off Fall Time       —       —         Total Gate Charge $V_{CS} = 10  \text{V}$ , $V_{CS} = 10 $	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ 0.6       -         Gate Threshold Voltage Temperature Coefficient $I_D = 1  \text{mA}$ , Referenced to 25°C       -       -1.4         Static Drain—Source On–Resistance $V_{GS} = 1.8  \text{V}$ , $I_D = 50  \text{mA}$ -       - $V_{GS} = 2.5  \text{V}$ , $I_D = 50  \text{mA}$ -       -       - $V_{GS} = 5  \text{V}$ , $I_D = 50  \text{mA}$ -       -         On–State Drain Current $V_{GS} = 10  \text{V}$ , $V_{DS} = 5  \text{V}$ 0.2       -         Forward Transconductance $V_{DS} = 10  \text{V}$ , $I_D = 200  \text{mA}$ 200       -         ARACTERISTICS         Input Capacitance $V_{DS} = 25  \text{V}$ , $V_{GS} = 0  \text{V}$ , $I_D = 200  \text{mA}$ 200       -         Beverse Transfer Capacitance $V_{DS} = 25  \text{V}$ , $V_{GS} = 10  \text{mV}$ -       281         CHARACTERISTICS $V_{DS} = 5  \text{V}$ , $V_{GS} = 10  \text{mV}$ -       281         CHARACTERISTICS $V_{DS} = 30  \text{V}$ , $V_{DS} = 30 $	ERISTICS         Gate Threshold Voltage         VDS = VGS, ID = 250 μA         0.6         -         1.2           Gate Threshold Voltage Temperature Coefficient         ID = 1 mA, Referenced to 25°C         -         -1.4         -           Static Drain-Source On-Resistance         VGS = 1.8 V, ID = 50 mA         -         -         2.5           VGS = 2.5 V, ID = 50 mA         -         -         2.0           VGS = 5 V, ID = 50 mA         -         -         1.6           On-State Drain Current         VGS = 10 V, VDS = 5 V         0.2         -         -           Forward Transconductance         VDS = 10 V, ID = 200 mA         200         -         -           Forward Transconductance         VDS = 25 V, VGS = 0 V, ID = 200 mA         200         -         -           Input Capacitance         VDS = 25 V, VGS = 10 mV         -         58         -           Output Capacitance         VDS = 5 V, VGS = 10 mV         -         281         -           CHARACTERISTICS         VDS = 5 V, VGS = 10 mV         -         281         -           CHARACTERISTICS         VDS = 30 V, ID = 0.29 A, VGS = 10 mV         -         -         5           Turn-On Blay Time         VDS = 25 V, ID = 0.2 A, VGS = 10 mA         -         -         -<

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **BSS138K**

### **TYPICAL CHARACTERISTICS**

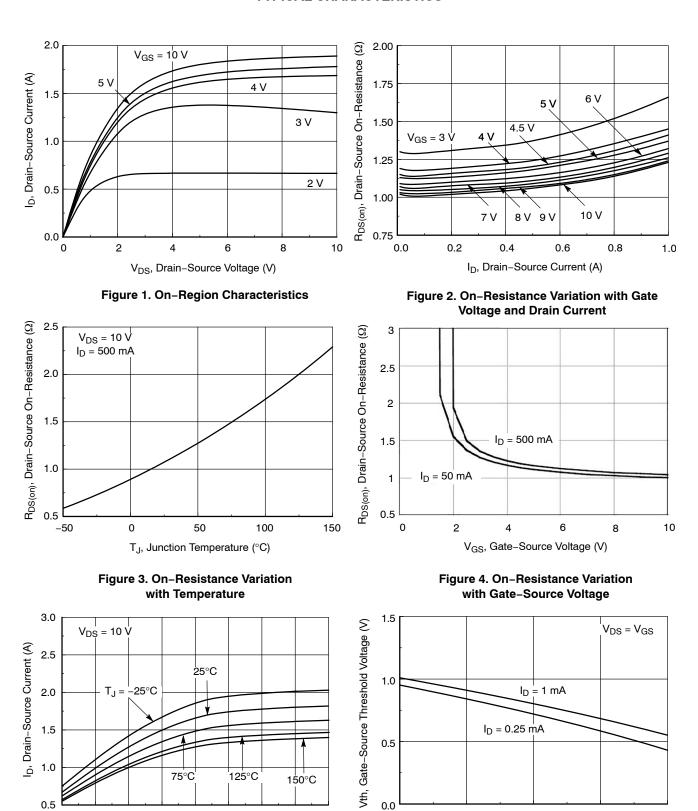


Figure 5. Transfer Characteristics

4.0

V<sub>GS</sub>, Gate-Source Voltage (V)

4.5

5.0

3.5

2.0

2.5

3.0

Figure 6. Gate Threshold Variation with Temperature

50

T<sub>J</sub>, Junction Temperature (°C)

100

150

0

-50

6.0

5.5

# **BSS138K**

# TYPICAL CHARACTERISTICS (continued)

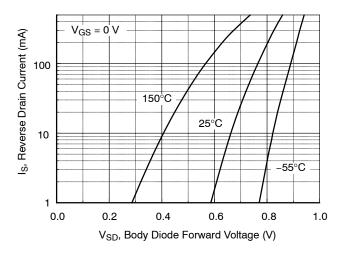


Figure 7. Reverse Drain Current Variation with Diode Forward Voltage and Temperature

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